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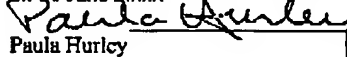
No. 0287 P. 1

JUN 30 2005

Attorney Docket No.: CPAC 1029-5

CERTIFICATE OF TRANSMISSION UNDER 37 CFR 1.8

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to the United States Patent and Trademark Office at Fax No. (703) 872-9306
on 30 June 2005.


Paula Hurley

30 June 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Marcos Karnezos

Application No. 10/681,583

Confirmation No.: 6814

Filed: 08 October 2003

Title: Semiconductor Multi-Package Module
Having Inverted Second Package Stacked Over
Die-down Flip-chip Ball Grid Array (BGA)
Package

Group Art Unit: 2841
Examiner: Unassigned

CUSTOMER NO. 22470

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

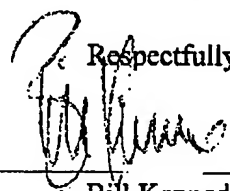
SECOND STATUS INQUIRY

Sir:

The last correspondence received from the Patent Office for the subject application is a Filing
Receipt mailed 09 March 2004. Please inform the undersigned when this application will be examined.

Respectfully submitted,

Dated: 30 June 2005


Bill Kennedy, Reg. No. 33,407

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